

**Amendments to the Specification:**

Please replace the paragraph beginning on page 1, line 5 with the following rewritten paragraph:

--This application relates to commonly assigned copending application Serial No. 10/648,419 (~~DN-83892~~) entitled PHOTOPATTERNING OF CONDUCTIVE ELECTRODE LAYERS CONTAINING ELECTRICALLY-CONTAINING POLYMER PARTICLES, application Serial No. 10/648,418 (~~DN-83943~~) entitled ELECTROGRAPHIC PATTERNING OF CONDUCTIVE ELECTRODE LAYERS CONTAINING ELECTRICALLY-CONDUCTIVE POLYMERIC MATERIALS, application Serial No. 10/648,421 (~~DN-84232~~) entitled METHOD OF PATTERNING AN ELECTROCONDUCTIVE LAYER ON A SUPPORT, filed simultaneously herewith. The copending applications are incorporated by reference herein for all that they contain.--